Sheet 1 of 2 Form PTO-1449 Docket Number (Optional) Application Number 4377.3US (99-1120.03/US) Not Yet Assigned INFORMATION DISCLOSURE CITATION Applicant Rita J. Klein IN AN APPLICATION (Use several sheets if necessary) Filing Date August 20, 2003 Group Art Unit Unknown **U.S. PATENT DOCUMENTS** DOCUMENT NUMBER EXAMINER FILING DATE DATE NAME CLASS SUBCLASS INITIAL IF APPROPRIATE 07/1973 3,748,137 Worth et al. 4.066,804 01/1978 **Andrews** 4,259,409 03/1981 Arnold 4,341,846 07/1982 Hough et al. 4,564,424 01/1986 Cassat et al. 4,565,606 01/1986 Cassat 4,816,070 03/1989 Holtzman et al. 4,882,202 11/1989 Holtzman et al. 5,260,234 11/1993 Long 5,268,259 12/1993 Sypula Kinoshita et al. 5,282,946 02/1994 5,318,803 06/1994 Bickford et al. 5,332,646 07/1994 Wright et al. 5,384,284 01/1995 Doan et al. 5,443,865 08/1995 Tisdale et al. FOREIGN PATENT DOCUMENTS DOCUMENT DATE CLASS **SUBCLASS** COUNTRY **NUMBER** YES NO OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.) STUMPF, Roland, et al., "Retardation of O Diffusion Through Polycrystalline Pt by Be Doping," Physical Review B, Vol. 59, No. 24, June 15, 1999, pp. 16 047-16 052. MALLORY, Glenn O. et al., eds. Electroless Plating: Fundamentals and Applications, pp. 432-440 (1990).YOUNAN et al., "Effect of heat treatment on electroless ternary nickel-cobalt-phosphorus allow," Journal of Applied Electrochemistry 32, pps. 439-446, 2002. DATE CONSIDERED EXAMINER .. hliv EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEF § 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to the applicant.

Sheet 2 of 2 Docket Number (Optional) Form PTO-1449 **Application Number** 4377.3US (99-1120.03/US) Not Yet Assigned INFORMATION DISCLOSURE CITATION Applicant Rita J. Klein IN AN APPLICATION (Use several sheets if necessary) Filing Date August 20, 2003 Group Art Unit Unknown **U.S. PATENT DOCUMENTS** FXAMINER DOCUMENT FILING DATE
IF APPROPRIATE DATE NAME CLASS SUBCLASS INITIAL NUMBER 5,523,173 06/1996 Doerner et al. 5,576,053 11/1996 Senda et al. 06/1997 5,639,316 Cabral, Jr. et al. 5,730,890 03/1998 Bickford et al. 5,789,027 08/1998 Watkins et al. Ramesh 5,838,035 11/1998 5,985,714 11/1999 Sandhu et al. Park et al. 12/1999 6,001,660 6,013,871 01/2000 Curtin 6,030,847 02/2000 Fazan et al. 6,320,213 11/2001 Kirlin et al. 6,348,709 02/2002 Graettinger et al. 12/2002 Gilton et al. 6,489,235 01/2003 Maydan et al. 6,503,375 BI FOREIGN PATENT DOCUMENTS Translation DOCUMENT COUNTRY CLASS SUBCLASS DATE NUMBER NO VES OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.) SCHLESINGER, Mordechay, "Electroplating," Electrochemistry Encyclopedia, Sep. 2002, 9 pages, http://electrochem.cwru.edu/ed/encycl/art-e01-electroplat.htm. DATE CONSIDERED **EXAMINER** EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP § 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to the applicant.